Integrated Circuit Systems, Inc.

ICS843071I
FEMTOCLOCKS™ CRYSTAL-TO- LVPECL
CLOCK GENERATOR

GENERAL DESCRIPTION

The ICS843071I is a Serial ATA (SATA)/Serial Attached SCSI (SAS) Clock Generator and a member of the HiPerClocks™ family of high performance devices from ICS. The ICS843071I uses an 18pF parallel resonant crystal over the range of 20.833MHz - 28.3MHz. For SATA/SAS applications, a 25MHz crystal is used and either 75MHz or 150MHz may be selected with the FREQ_SEL pin. For 10Gb Fibre Channel applications, a 26.5625MHz crystal is used for 159.375MHz output. The ICS843071I has excellent <1ps phase jitter performance, over the 12kHz - 20MHz integration range. The ICS843071I is packaged in a small 8-pin TSSOP, making it ideal for use in systems with limited board space.

FEATURES

- One Differential LVPECL output

- Crystal oscillator interface, 18pF parallel resonant crystal (20.833MHz - 28.3MHz)

- Output frequency range: 62.5MHz - 170MHz

- VCO range: 500MHz - 680MHz

- RMS phase jitter @ 150MHz, using a 25MHz crystal (12kHz - 20MHz): 0.64ps (typical) @ 3.3V output

- RMS phase jitter @ 159.375MHz, using a 26.5625MHz crystal (1.875MHz - 20MHz): 0.40ps (typical) @ 3.3V output

- 3.3V or 2.5V operating supply

- -40°C to 85°C ambient operating temperature

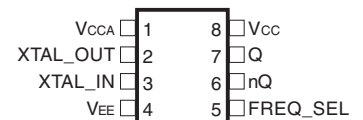- Available in both standard and lead-free RoHS compliant packages

COMMON CONFIGURATION TABLE - SERIAL ATA/SERIAL ATTACHED SCSI

Inputs					Output Frequency (MHz)
Crystal Frequency (MHz)	FREQ_SEL	M	N	Multiplication Value M/N	
25	0	24	4	6	150
25	1	24	8	3	75
26.5625	0	24	4	6	159.375

BLOCK DIAGRAM
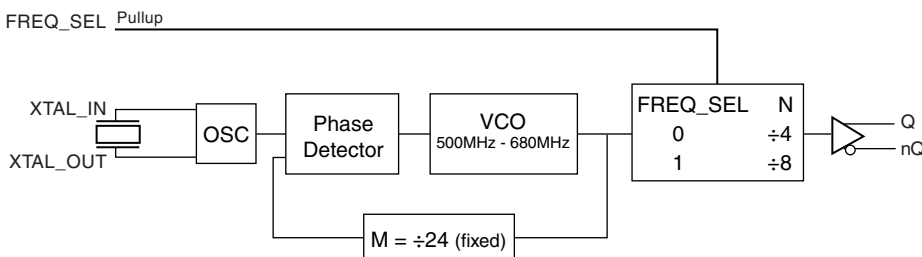
PIN ASSIGNMENT

ICS843071I
8-Lead TSSOP
4.40mm x 3.0mm x 0.925mm
package body
G Package
Top View

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TABLE 1. PIN DESCRIPTIONS

Number	Name	Type		Description
1	V_{CCA}	Power		Analog supply pin.
2, 3	XTAL_OUT, XTAL_IN	Input		Crystal oscillator interface. XTAL_IN is the input, XTAL_OUT is the output.
4	V_{EE}	Power		Negative supply pin.
5	FREQ_SEL	Input	Pullup	Frequency select pin. LVCMOS/LVTTL interface levels.
6, 7	nQ, Q	Output		Differential clock outputs. LVPECL interface levels.
8	V_{CC}	Power		Core supply pin.

NOTE: *Pullup* refers to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C_{IN}	Input Capacitance			4		pF
R_{PULLUP}	Input Pullup Resistor			51		kΩ

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD} 4.6V

Inputs, V_I -0.5V to V_{CC} + 0.5 V

Outputs, I_O (LVDS)
 Continuous Current 10mA
 Surge Current 15mA

Package Thermal Impedance, θ_{JA} 101.7°C/W (0 mps)

Storage Temperature, T_{STG} -65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 3A. POWER SUPPLY DC CHARACTERISTICS, $V_{CC} = V_{CCA} = 3.3V\pm10\%$, $T_A = -40°C$ TO $85°C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{CC}	Positive Supply Voltage		3.0	3.3	3.63	V
V_{CCA}	Analog Supply Voltage		3.0	3.3	3.63	V
I_{CC}	Power Supply Current				96	mA
I_{CCA}	Analog Supply Current				12	mA
I_{EE}	Power Supply Current				72	mA

TABLE 3B. POWER SUPPLY DC CHARACTERISTICS, $V_{CC} = V_{CCA} = 2.5V\pm10\%$, $T_A = -40°C$ TO $85°C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{CC}	Positive Supply Voltage		2.25	2.5	2.75	V
V_{CCA}	Analog Supply Voltage		2.25	2.5	2.75	V
I_{CC}	Power Supply Current				72	mA
I_{CCA}	Analog Supply Current				12	mA
I_{EE}	Power Supply Current				72	mA

TABLE 3C. LVCMOS/LVTTL DC CHARACTERISTICS, $V_{CC} = V_{CCA} = 3.3V\pm10\%$ OR $2.5V\pm10\%$, $T_A = -40°C$ TO $85°C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage	3.3V	2		V_{CC} + 0.3	V
		2.5V	1.7		V_{CC} + 0.3	V
V_{IL}	Input Low Voltage	3.3V	-0.3		0.8	V
		2.5V	-0.3		0.7	V
I_{IH}	Input High Current	$V_{CC} = V_{IN} = 3.63V$ or $2.75V$			5	µA
I_{IL}	Input Low Current	$V_{CC} = 3.63V$ or $2.75V$, $V_{IN} = 0V$	-150			µA

TABLE 3D. LVPECL DC CHARACTERISTICS, $V_{CC} = V_{CCA} = 3.3V \pm 10\%$ OR $2.5V \pm 10\%$, TA = -40°C TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{OH}	Output High Voltage; NOTE 1		V_{CC} - 1.4		V_{CC} - 0.9	V
V_{OL}	Output Low Voltage; NOTE 1		V_{CC} - 2.0		V_{CC} - 1.7	V
V_{SWING}	Peak-to-Peak Output Voltage Swing		0.6		1.0	V

NOTE 1: Outputs terminated with 50Ω to V_{CC} - 2V.

TABLE 4. CRYSTAL CHARACTERISTICS

Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation			Fundamental		
Frequency		20.833		28.3	MHz
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitance				7	pF
Drive Level				1	mW

TABLE 5A. AC CHARACTERISTICS, $V_{CC} = V_{CCA} = 3.3V \pm 10\%$, TA = -40°C TO 85°C

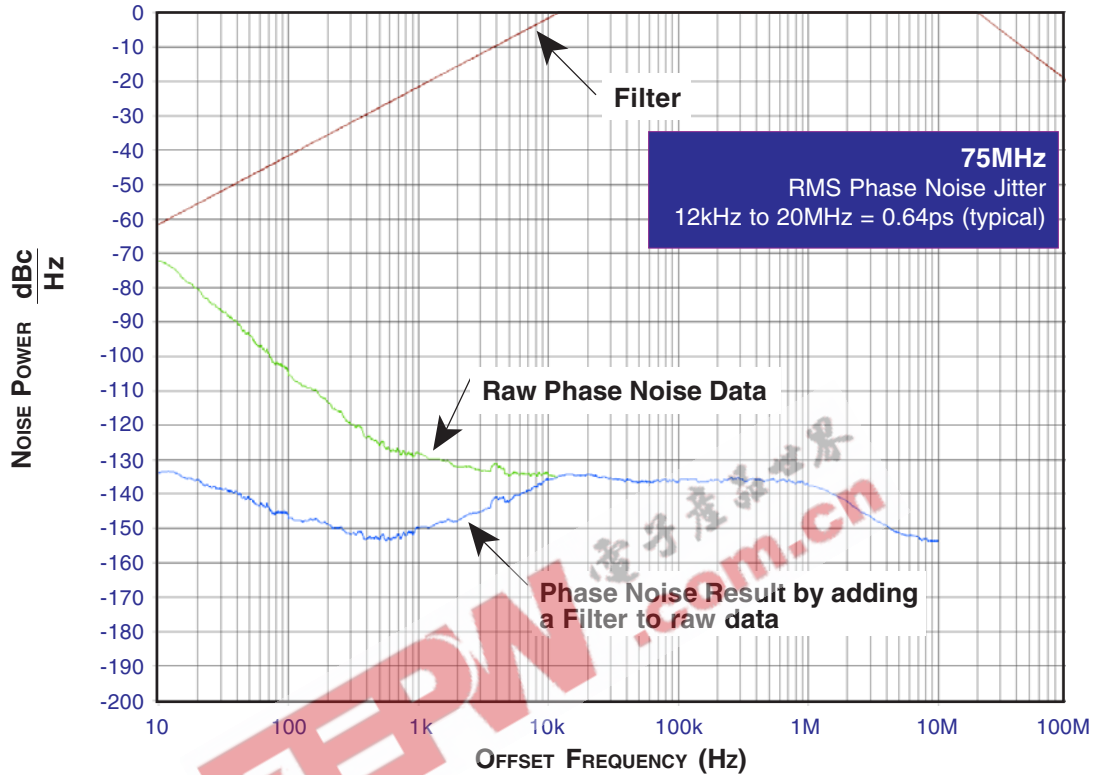| Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{OUT}	Output Frequency		62.5		170	MHz
$tjit(\emptyset)$	RMS Phase Jitter (Random); NOTE 1	150MHz @ Integration Range: 12kHz - 20MHz		0.64		ps
		75MHz @ Integration Range: 12kHz - 20MHz		0.64		ps
		159.375MHz @ Integration Range: 1.875MHz - 20MHz		0.40		ps
t_R / t_F	Output Rise/Fall Time	20% to 80%	250		500	ps
odc	Output Duty Cycle		48		52	%

NOTE 1: Please refer to the Phase Noise Plots following this section.

TABLE 5B. AC CHARACTERISTICS, $V_{CC} = V_{CCA} = 2.5V \pm 10\%$, TA = -40°C TO 85°C

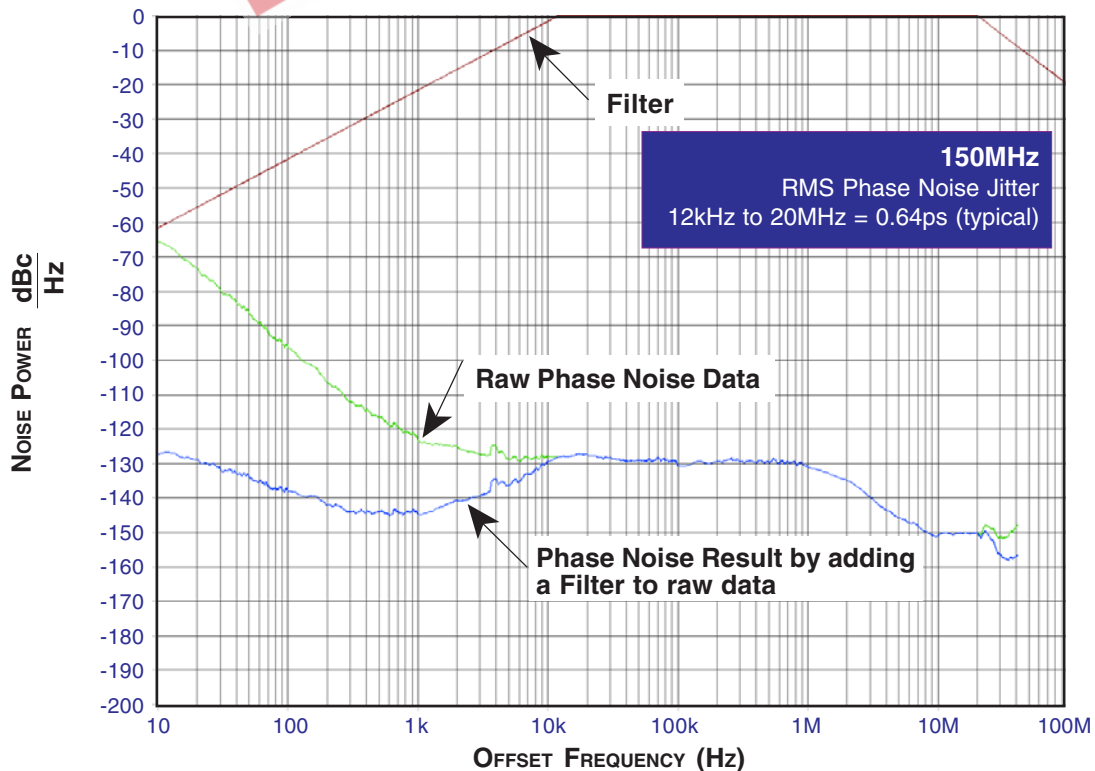| Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{OUT}	Output Frequency		62.5		170	MHz
$tjit(\emptyset)$	RMS Phase Jitter (Random)	150MHz @ Integration Range: 12kHz - 20MHz		0.94		ps
		75MHz @ Integration Range: 12kHz - 20MHz		0.80		ps
		159.375MHz @ Integration Range: 1.875MHz - 20MHz		0.42		ps
t_R / t_F	Output Rise/Fall Time	20% to 80%	250		500	ps
odc	Output Duty Cycle		48		52	%

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TYPICAL PHASE NOISE AT 75MHz @ 3.3V

75MHz
RMS Phase Noise Jitter
12kHz to 20MHz = 0.64ps (typical)

Filter

Raw Phase Noise Data

Phase Noise Result by adding a Filter to raw data

NOISE POWER $\frac{dBc}{Hz}$

OFFSET FREQUENCY (Hz)

TYPICAL PHASE NOISE AT 150MHz @ 3.3V

150MHz
RMS Phase Noise Jitter
12kHz to 20MHz = 0.64ps (typical)

Filter

Raw Phase Noise Data

Phase Noise Result by adding a Filter to raw data

NOISE POWER $\frac{dBc}{Hz}$

OFFSET FREQUENCY (Hz)

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TYPICAL PHASE NOISE AT 159.375MHz @ 3.3V

10Gb Fibre Channel Filter

159.375MHz
RMS Phase Noise Jitter
1.875MHz to 20MHz = 0.40ps (typical)

Raw Phase Noise Data

Phase Noise Result by adding a 10Gb Fibre Channel Filter to raw data

NOISE POWER $\frac{dBc}{Hz}$

OFFSET FREQUENCY (Hz)

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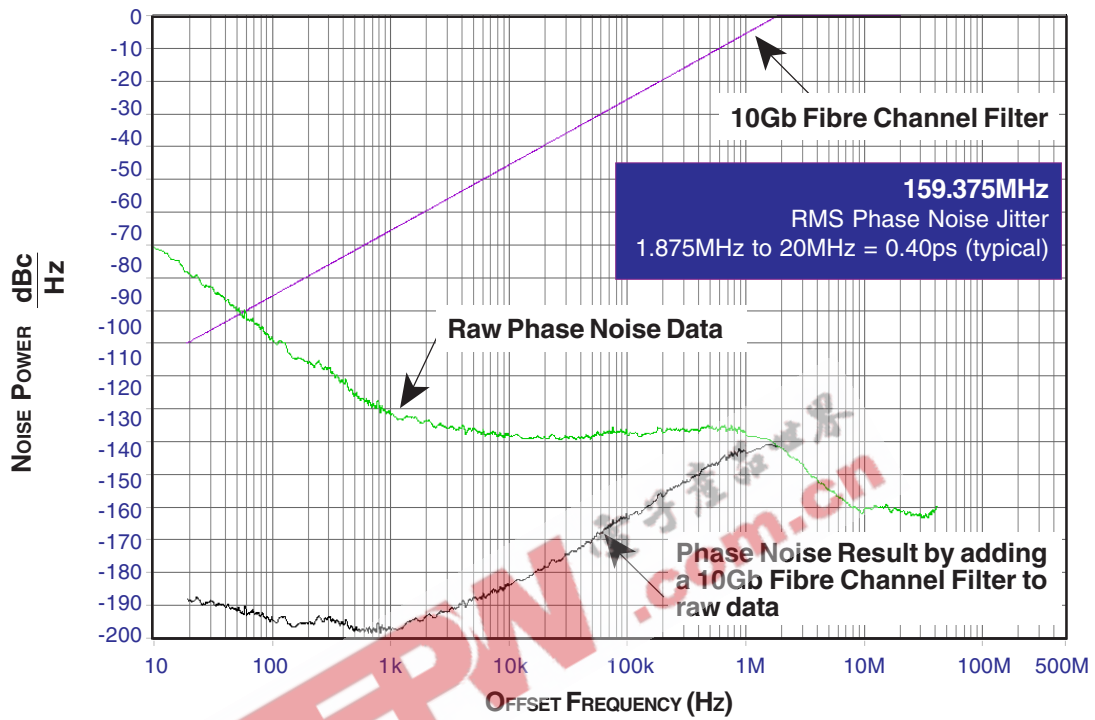
PARAMETER MEASUREMENT INFORMATION
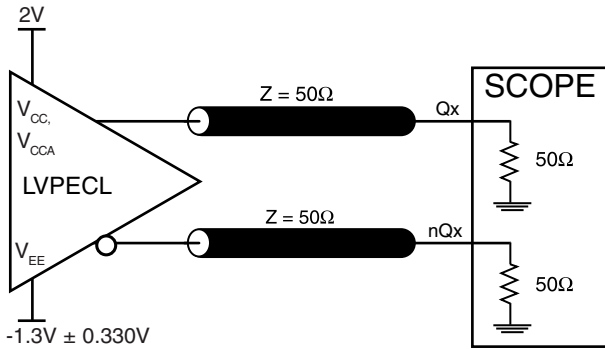
LVPECL 3.3V OUTPUT LOAD AC TEST CIRCUIT
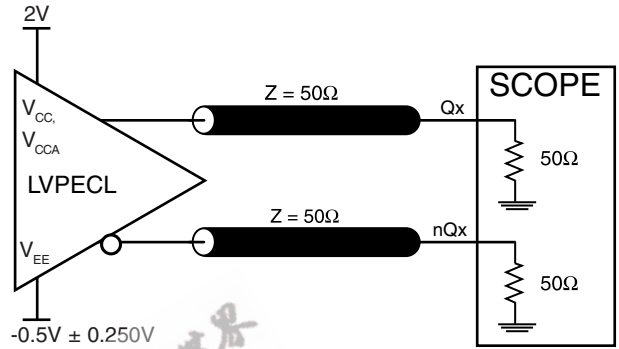
LVPECL 2.5V OUTPUT LOAD AC TEST CIRCUIT
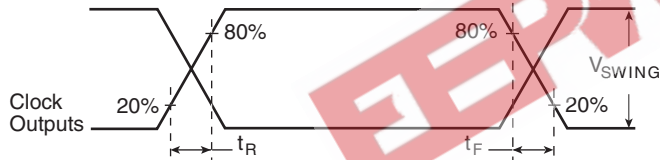
OUTPUT RISE/FALL TIME
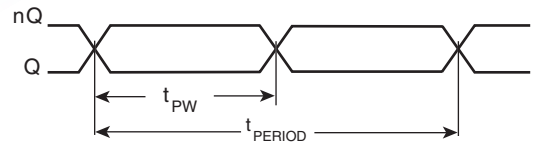
$$odc = \frac{t_{PW}}{t_{PERIOD}} \times 100\%$$

OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD
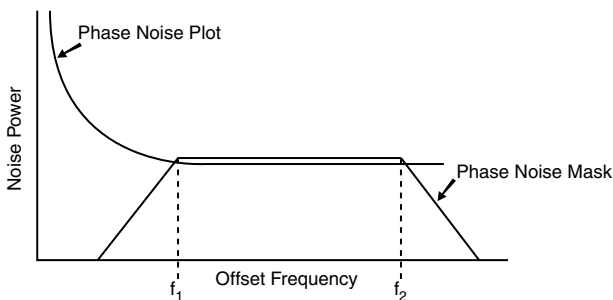
RMS Jitter = $\sqrt{\text{Area Under the Masked Phase Noise Plot}}$

RMS PHASE JITTER

APPLICATION **I**NFORMATION

POWER **S**UPPLY **F**ILTERING **T**ECHNIQUES

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. The ICS843071I provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL. V_{CC} and V_{CCA} should be individually connected to the power supply plane through vias, and bypass capacitors should be used for each pin. To achieve optimum jitter performance, power supply isolation is required. *Figure 1* illustrates how a 10Ω resistor along with a 10µF and a .01µF bypass capacitor should be connected to each V_{CCA} pin.
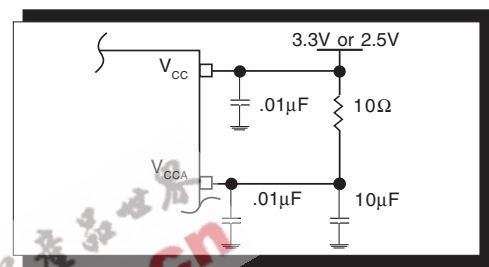
FIGURE **1. P**OWER **S**UPPLY **F**ILTERING

CRYSTAL **I**NPUT **I**NTERFACE

The ICS843071I has been characterized with 18pF parallel resonant crystals. The capacitor values, C1 and C2, shown in *Figure 2* below were determined using an 18pF parallel reso-nant crystal and were chosen to minimize the ppm error. The optimum C1 and C2 values can be slightly adjusted for differ-ent board layouts.
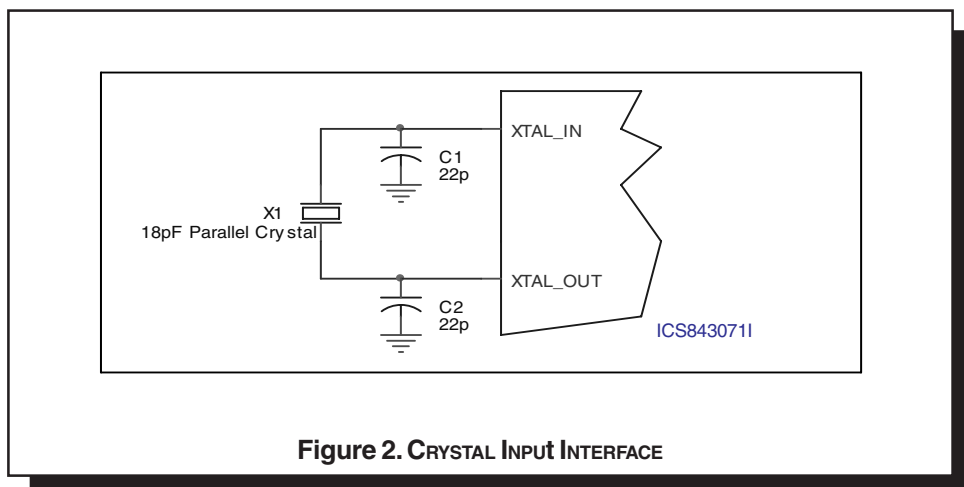

Figure 2. CRYSTAL **I**NPUT **I**NTERFACE

Termination for 3.3V LVPECL Output

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

FOUT and nFOUT are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are designed to

drive 50Ω transmission lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 3A and 3B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.
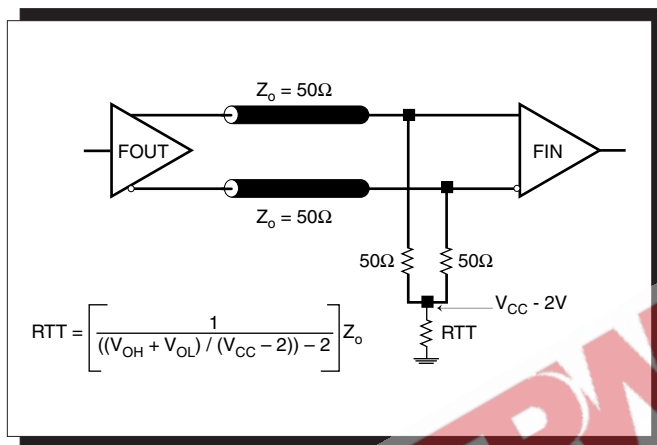

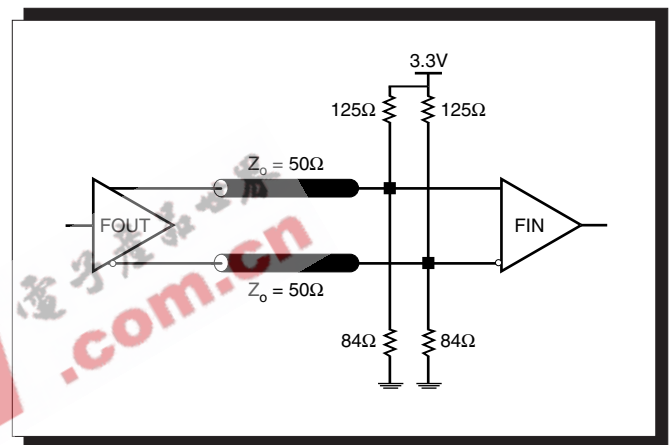$$RTT = \left[\frac{1}{((V_{OH} + V_{OL}) / (V_{CC} - 2)) - 2} \right] Z_o$$

FIGURE 3A. LVPECL Output Termination

FIGURE 3B. LVPECL Output Termination

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TERMINATION FOR 2.5V LVPECL OUTPUT

Figure 4A and *Figure 4B* show examples of termination for 2.5V LVPECL driver. These terminations are equivalent to terminating 50Ω to V_{CC} - 2V. For V_{CC} = 2.5V, the V_{CC} - 2V is very close to ground level. The R3 in Figure 4B can be eliminated and the termination is shown in *Figure 4C.*
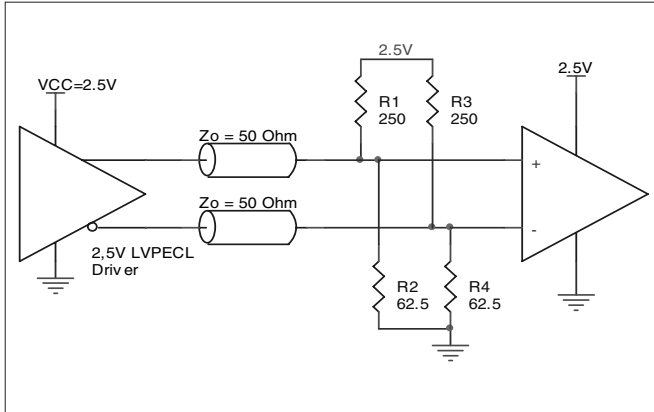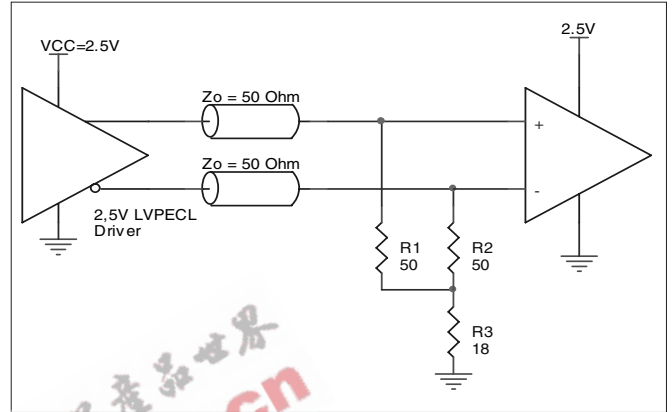

FIGURE 4A. 2.5V LVPECL DRIVER TERMINATION EXAMPLE

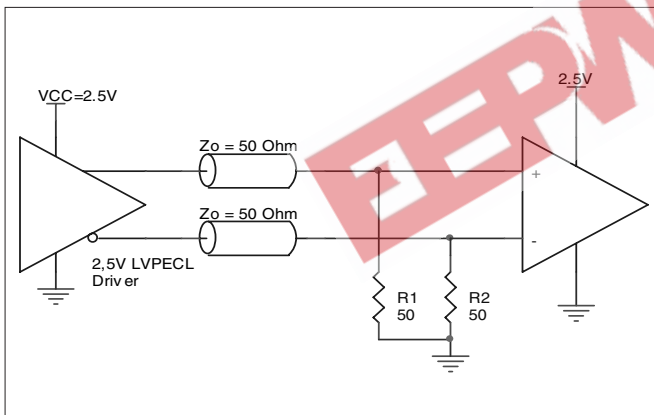**FIGURE 4B. 2.5V LVPECL DRIVER TERMINATION EXAMPLE**

FIGURE 4C. 2.5V LVPECL TERMINATION EXAMPLE

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POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the ICS843071I.
Equations and example calculations are also provided.

1. Power Dissipation.
The total power dissipation for the ICS843071I is the sum of the core power plus the power dissipated in the load(s).
The following is the power dissipation for V_{CC} = 3.3V + 10% = 3.63V, which gives worst case results.
NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)$_{MAX}$ = V_{CC_MAX} * I_{EE_TYP} = 3.63V * 96mA = **348.5mW**

- Power (outputs)$_{MAX}$ = **30mW/Loaded Output pair**

    Total Power $_{MAX}$ (3.63V, with all outputs switching) = 348.5mW + 30mW = **378.5mW**

2. Junction Temperature.
Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

    The equation for Tj is as follows: Tj = θ_{JA} * Pd_total + T_A

    Tj = Junction Temperature

    θ_{JA} = Junction-to-Ambient Thermal Resistance

    Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)

    T_A = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{JA} must be used. Assuming a moderate air flow of 1 meter per second and a multi-layer board, the appropriate value is 90.5°C/W per Table 6 below.

Therefore, Tj for an ambient temperature of 85°C with all outputs switching is:
    85°C + 0.379W * 90.5°C/W = 119.3°C. This is below the limit of 125°C.

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

TABLE 6. THERMAL RESISTANCE θ_{JA} FOR 8-PIN TSSOP, FORCED CONVECTION

θ_{JA} by Velocity (Meters per Second)			
	0	1	2.5
Multi-Layer PCB, JEDEC Standard Test Boards	101.7°C/W	90.5°C/W	89.8°C/W

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3. Calculations and Equations.
The purpose of this section is to derive the power dissipated into the load.
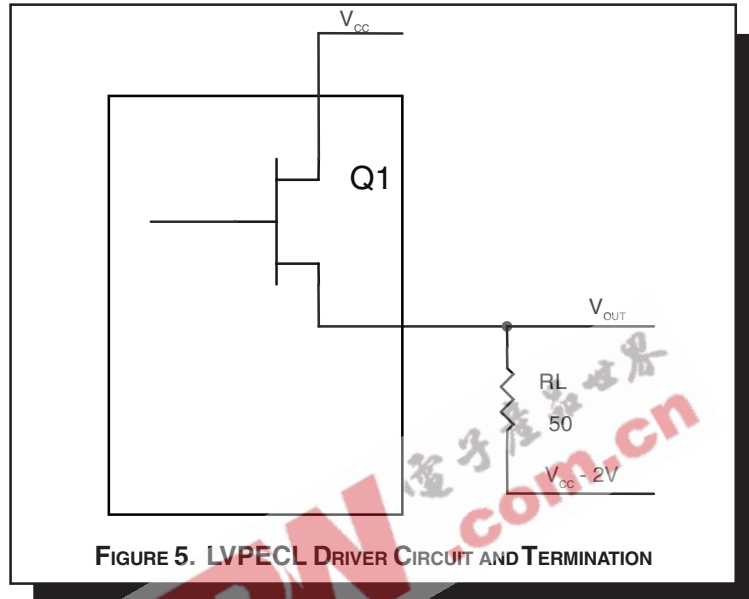LVPECL output driver circuit and termination are shown in *Figure 5.*

FIGURE 5. LVPECL DRIVER CIRCUIT AND TERMINATION

To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination voltage of V_{cc} - 2V.

- For logic high, $V_{OUT} = V_{OH\_MAX} = \mathbf{V_{CC\_MAX} - 0.9V}$

  $(V_{CCO\_MAX} - V_{OH\_MAX}) = \mathbf{0.9V}$

- For logic low, $V_{OUT} = V_{OL\_MAX} = \mathbf{V_{CC\_MAX} - 1.7V}$

  $(V_{CCO\_MAX} - V_{OL\_MAX}) = \mathbf{1.7V}$

Pd_H is power dissipation when the output drives high.
Pd_L is the power dissipation when the output drives low.

$Pd\_H = [(V_{OH\_MAX} - (V_{CC\_MAX} - 2V))/R_L] * (V_{CC\_MAX} - V_{OH\_MAX}) = [(2V - (V_{CC\_MAX} - V_{OH\_MAX}))/R_L] * (V_{CC\_MAX} - V_{OH\_MAX}) =$
$[(2V - 0.9V)/50\Omega] * 0.9V = \mathbf{19.8mW}$

$Pd\_L = [(V_{OL\_MAX} - (V_{CC\_MAX} - 2V))/R_L] * (V_{CC\_MAX} - V_{OL\_MAX}) = [(2V - (V_{CC\_MAX} - V_{OL\_MAX}))/R_L] * (V_{CC\_MAX} - V_{OL\_MAX}) =$
$[(2V - 1.7V)/50\Omega] * 1.7V = \mathbf{10.2mW}$

Total Power Dissipation per output pair = Pd_H + Pd_L = **30mW**

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RELIABILITY INFORMATION

TABLE 7. θ_{JA} VS. AIR FLOW TABLE FOR 8 LEAD TSSOP

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	**1**	**2.5**
Multi-Layer PCB, JEDEC Standard Test Boards	101.7°C/W	90.5°C/W	89.8°C/W

TRANSISTOR COUNT

The transistor count for ICS843071I is: 1732

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PACKAGE OUTLINE - G SUFFIX FOR 8 LEAD TSSOP
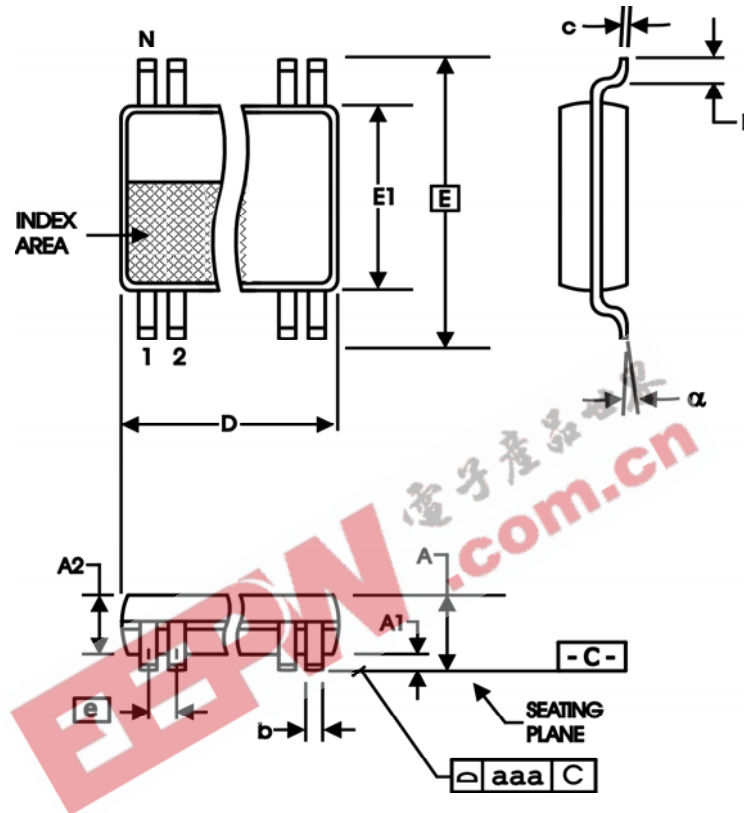
TABLE 8. PACKAGE DIMENSIONS

SYMBOL	Millimeters	
	Minimum	Maximum
N	8	
A	--	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	2.90	3.10
E	6.40 BASIC	
E1	4.30	4.50
e	0.65 BASIC	
L	0.45	0.75
α	0°	8°
aaa	--	0.10

Reference Document: JEDEC Publication 95, MO-153

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TABLE 9. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS843071AGI	3071A	8 Lead TSSOP	tube	-40°C to 85°C
ICS843071AGIT	3071A	8 Lead TSSOP	2500 tape & reel	-40°C to 85°C
ICS843071AGILF	TBD	8 Lead "Lead-Free" TSSOP	tube	-40°C to 85°C
ICS843071AGILFT	TBD	8 Lead "Lead-Free" TSSOP	2500 tape & reel	-40°C to 85°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.